

C1206X102J1GACTU

Aliases (C1206X102J1GAC7800) SMD Comm COG Flex, Ceramic, 1,000 pF, 5%, 100 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1206, 1.5 mm



General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	15 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	1206
L	3.3mm +/-0.4mm
W	1.6mm +/-0.35mm
Т	0.78mm +/-0.20mm
S	1.5mm MIN
В	0.6mm +/-0.25mm

W	1.6mm +/-0.35mm	Tolerance	5%
Т	0.78mm +/-0.20mm	Voltage DC	100 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	250 VD0
В	0.6mm +/-0.25mm	Temperature Range	-55/+125
		Temp. Coefficient	COG
Packaging Specifications		Capacitance Change with	30 ppm/
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	
Packaging Quantity	4000	Dissipation Factor	∩ 1% 1 MI

Specifications	
Capacitance	1,000 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	100 VDC
Dielectric Withstanding Voltage	250 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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